## 212 Gb/s PAM4 per Lane C2M Channels A Via Length Performance Study Supplement




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## 200G PAM4 C2M Via Length Effect Study Supplement

## Supporter

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## 200G PAM4 C2M Via Length Effect Study Supplement Objectives

- Follow up to presentation given on September $21^{\text {st }}, 2022$
- Study the effect of via length in channel performance
$\checkmark$ Via lengths $=19 / 67 / 93 / 135 \mathrm{mil}$
- Evaluated channel performance using COM rev. 3.9 and corresponding new spreadsheets.
- Investigate the effect of Raised Cosine vs. Butterworth filter performance
- Illustrate the paradox when cascading s-parameters of vias and connector models

The intention of this presentation is NOT to:
$\checkmark$ Discuss specific materials
$\checkmark$ Discuss specific equalizations/implementations
$\checkmark$ Discuss specific ASIC footprints
$\checkmark$ Recommend specific receive filters
The intention of this presentation is to:
$\checkmark$ Contribute two additional "optimized" channels based on "actual" channel implementations which includes the ASIC breakout, routing, via transitions, and the latest OSFP model available
$>$ Via antipads in PCB inner layers were optimized using HFSS Optimetrix
$\checkmark$ Provide channels with impairments that seasoned design engineers will encounter when implementing channels operating at $224 \mathrm{~Gb} /$ s per lane.
$\checkmark$ Analyze receiver equalization solutions to pass COM rev. 3.9

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## C2M Channel Highlights

- Traditional Topology, i.e., medium PCB material between ASIC and Connector
* Short Channel - Ex. NIC card
- Short Host Channel
* Well engineered challenging channel
* Includes Huray model for copper roughness
- Channel with IMPAIRMENTS
* ASIC/Connector vias and module finger transition
* Layout trace turns
* Skew compensation
* Full channel crosstalk
- MDI is an OSFP connector model
- Crosstalk source mostly at the connector and footprint
- HCB - Ideal transmission line with IL=4.0 dB @ Nyquist
- COM rev. 3.9 - Includes raise cosine option


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## Structure View \& Insertion Losses



- Full Structure:
- Two adjacent channels
$>$ Matching segmentation meshing (i.e., common minimum element size)
- Connector integrated with PCB
- HCB is ideal transmission line with IL $=4 \mathrm{~dB}$ @ Nyquist
- NEXT is evaluated at the ASIC model for more realistic results
- Vias = 19/67/93/135 mil long
- Blind Vias
- Frequency Sweep Range = 10 MHz to 120 GHz

> IL @ Nyquist (53.125 GHz)

## Parallel Breakout

- IL PCB+Conn $=8.24 / 9.32 / 10.31 / 8.92 \mathrm{~dB}$
- IL нCB $=4 \mathrm{~dB}$
- IL TPO-to-TP1a $=12.27 / 13.32 / 13.44 / 12.93 \mathrm{~dB}$

Orthogonal Breakout

- IL PCB+Conn $=8.34 / 10.69 / 10.14 / 9.33 \mathrm{~dB}$
- IL HCB $=4 \mathrm{~dB}$
- IL TPO-to-TP1a = 12.38/14.69/14.17/13.36 dB


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Two ASIC breakouts: Orthogonal vs. Parallel

Orthogonal Breakout


Parallel Breakout


## 200G PAM4 C2M Via Length Effect Study Supplement ASIC Ball Model Example



Cp already included in model $=>\mathrm{Cp}=0$

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## Parallel Breakout - IL/RL Performance




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## Parallel Breakout - IL/RL Performance



135 mil

RL_L14_XtraExtendedVias_C2M_P... Ansys


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## Parallel Breakout - FEXT/NEXT(ASIC) Performance

19 mil



67 mil



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## Parallel Breakout - FEXT/NEXT(ASIC) Performance

93 mil



135 mil


NEXT_L14_XtraExtendedVias_C2M_... Ansys


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## Orthogonal Breakout - IL/RL Performance



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## Orthogonal Breakout - IL/RL Performance



## 200G PAM4 C2M Via Length Effect Study Supplement

 Orthogonal Breakout - FEXT/NEXT(ASIC) Performance19 mil



67 mil



## 200G PAM4 C2M Via Length Effect Study Supplement

## Orthogonal Breakout - FEXT/NEXT(ASIC) Performance

93 mil



135 mil


NEXT_L14_XtraExtendedVias_C2M Ansys


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## Structures and COM Configurations

- Four Via Lengths:
$\checkmark 19$ mil - 67 mil - 93 mil - 135 mil
- Two Breakouts:
$\checkmark$ Parallel
$\checkmark$ Orthogonal
- Medium Package Size $=30 \mathrm{~mm}$
- Two Filters:
$\checkmark$ Butterworth
$\checkmark$ Raised Cosine (starts @ 67 GHz, ends @ 79.7 GHz)*
- With PKG_Tx_FFE_Preset*
- Floating Taps:
$\checkmark 6$ groups/3 taps per group/120 UI span
- $\quad D E R=1 e-05$ and $5 e-5$
* Note: Default values in contributed spreadsheets


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## COM Results

| 2 FEXTs - 1 NEXT - Medium Size Package ( 30 mm ) |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Orthogonal Breakout |  |  |  |  |  |  |  |  |  |  |  |
| Case \# | Via Length | PKG_TX_FFE_Preset | Filter | DER_0 | SNR_TX | eta_0 | Float. Taps | EH (mV) | $\mathrm{VEC}(\mathrm{dB})$ | ERL (dB) | ICN |
| 1 | 19 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 10.3 | 8.63 | 17.6 | 1.47 |
| 2 | 67 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 8.7 | 9.88 | 16.6 | 2.04 |
| 3 | 93 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 6.7 | 11.21 | 15.5 | 2.27 |
| 4 | 135 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 4.5 | 13.85 | 15.5 | 2.83 |
| 5 | 135 mil | Yes | Rcin+ BW | 5.00E-05 | 32.5 | 4.10E-09 | Yes | 6.2 | 11.14 | 16.1 | 2.83 |
|  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |  |  |
| 2 FEXTs - 1 NEXT - Medium Size Package ( 30 mm ) |  |  |  |  |  |  |  |  |  |  |  |
| Paralell Breakout |  |  |  |  |  |  |  |  |  |  |  |
| Case \# | Via Length | PKG_TX_FFE_Preset | Filter | DER_0 | SNR_TX | eta_0 | Float. Taps | EH (mV) | $\mathrm{VEC}(\mathrm{dB})$ | ERL (dB) | ICN |
| 1 | 19 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 9.5 | 8.79 | 17.6 | 1.79 |
| 2 | 67 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 7.9 | 10.28 | 16.6 | 2.36 |
| 3 | 93 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 6.9 | 11.15 | 15.4 | 2.62 |
| 4 | 135 mil | Yes | Rcin+ BW | 1.00E-05 | 32.5 | 4.10E-09 | Yes | 5.6 | 13.36 | 15.5 | 3.25 |
| 5 | 135 mil | Yes | Rcin+ BW | 5.00E-05 | 32.5 | 4.10E-09 | Yes | 7.5 | 10.80 | 16.1 | 3.25 |

* Pass: VECmax = 12 ; ERLmin = 10


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## COM Results Highlights

Longer vias require additional equalization features regardless of the ASIC breakout style:

- Stronger filter in addition to traditional Butterworth
> Raised Cosine or equivalent
- Reduce receiver intrinsic noise
- Higher SNR
- Stronger FEC (segmented?) to account for higher DER
- Floating DFE taps or equivalent


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## Modeling Paradox - Via + Connector $=$ Via and Connector

Cascading s-parameters from different sources has risks:

- Actual x-talk is lost by interconnecting non-TEM boundaries.
- Cascading s-parameters from different sources
$\checkmark$ Missing interconnect structure pieces and phase information
$\checkmark$ Double counting of transitions and creating phase distortion
- Unaccounted meshing mismatch
> Build channel model with a "holistic" approach
* Channel model should NOT be just an aggregate of s-parameter structures
* Channel should be segmented with wave ports along uniform transmission lines several wavelengths away from discontinuities.

Example:



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## Summary

"Equal Distribution of PAIN" to make C2M a viable interface

Longer PCB via solutions are feasible but:

1. Need to optimize via transitions

- Cancel via capacitive and inductive effects
- Optimize connector to module PCB transition

2. Stronger FEC to support higher DER

- Segmented FEC (?)

3. Enhanced Receiver Equalization (compared to P802.3ck):

- Stronger filter
- Higher SNR
- Include floating taps option or equivalent
- Reduce intrinsic chip noise
> Channel Modeling: Take a holistic approach


## Q \& A

## Additional Data

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## Working Spreadsheet



| Table 93A-3 parameters |  |  |
| :---: | :---: | :---: |
| Parameter | Setting | Units |
| package_t1_gamm30_1__32 | [ 00.00084550 .000340225 ] |  |
| package_ti_tau | 0.00644805 | ns/mm |
| package_Z_s | [9292;7070; 8080; 100100 ] | Ohm |
| Parameter | Setting |  |
| board_t1_gamma0_a ${ }^{\text {a }}$ a 2 | [06.44084e-4 3.6036e-05] | $1.5 \mathrm{db} / \mathrm{in}$ @ 56 G |
| board_tl_tau | 5.790E.03 | ns/mm |
| board_Z_c | 100 | Ohm |
| 2_bp (TX) | 125 | mm |
| z_bp ( (EXT) | 0 | mm |
| 2_bp(FEXT) | 125 | mm |
| z_bp (RX) | , | mm |
| c_o | [0.2e-40] | nF |
| c_1 | [0.2e-40] | nF |
| Include PCB | 0 | logical |
|  |  |  |
| Seletions [rectangle, gaussian,dual_rayleigh,triangle |  |  |
| Histogram_Window_Weight | gaussian | selection |
| ar | 0.02 | UI |



## 200G PAM4 C2M Via Length Effect Study Supplement

## Channel Contributions*

|  |  |
| :---: | :---: |
|  | Rabinovich_C2M_200G_Paral_19mil_092122_NEXT.s4p |
|  | Rabinovich_C2M_200G_Paral_19mil_092122_Thru.s4p** |
|  | Rabinovich_C2M_200G_Paral_67mil_092122_FEXT.s4p** |
|  | Rabinovich_C2M_200G_Paral_67mil_092122_NEXT.s4p** |
|  | Rabinovich_C2M_200G_Paral_67mil_092122_Thru |
|  | Rabinovich_C2M_200G_Paral_93mil_092122_FEXT.s4p** |
|  | Rabinovich_C2M_200G_Paral_93mil_092122_NEXT.s4p** |
|  | Rabinovich_C2M_200G_Paral_93mil_092122_Thru |
|  | Rabinovich_C2M_200G_Paral_135mil_011723_FEX |
|  | Rabinovich_C2M_200G_Paral_135mil_011723 |
|  | Rabinovich_C2M_200G_Paral_135mil_011723 _Thru.s4p |
|  | Rabinovich_C2M_200G_Ortho_19mil_092122 |
|  | Rabinovich_C2M_200G_Ortho_19mil_092122 |
|  | Rabinovich_C2M_200G_Ortho_19mil_092122_Thru.s4p** |
|  | Rabinovich_C2M_200G_Ortho_67mil_092122_FEX |
|  | Rabinovich_C2M_200G_Ortho_67mil_092122_NEXT.s4 |
|  | Rabinovich_C2M_200G_Ortho_67mil_092122_Thru.s4p** |
|  | Rabinovich_C2M_200G_Ortho_93mil_092122_FEXT.s4p** |
|  | Rabinovich_C2M_200G_Ortho_93mil_092122_NEXT.s4p |
|  | Rabinovich_C2M_200G_Ortho_93mil_092122_Thru.s4p** |
|  | Rabinovich_C2M_200G_Ortho_135mil_011723 _FEXT. |
|  | Rabinovich_C2M_200G_Ortho_135mil_011723 _NEX |
|  | Rabinovich_C2M_200G_Ortho_135mil_011723 _Thru.s4 |


** Note: Released on 9/21/22

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## IL Comparison Between Butterworth and Raise Cosine Filters



* Source: Mellitz_3df_elec_01_220621.pdf

